74AVC16374-Q100

16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

Rev. 2 — 16 March 2015

Product data sheet

1. General description

The 74AVC16374-Q100 is a 16-bit edge triggered flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. The 74AVC16374-Q100 consist of 2 sections of 8 edge-triggered flip-flops. A clock input (CP) and an output enable (\overline{OE}) are provided per 8-bit section.

The 74AVC16374-Q100 is designed to have an extremely fast propagation delay and a minimum amount of power consumption.

To ensure the high-impedance output state during power-up or power-down, nOE should be tied to VCC through a pull-up resistor (Live Insertion).

A Dynamic Controlled Output (DCO) circuitry is implemented to support termination line drive during transient (see Figure 5 and Figure 6).

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 3) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 3)
 - ◆ Specified from -40 °C to +85 °C
- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standards:
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - ◆ JESD8-5 (1.8 V to 2.7 V)
 - ◆ JESD8-1A (2.7 V to 3.6 V)
- ESD protection:
 - ◆ MIL-STD-883, method 3015 exceeds 1000 V
 - HBM JESD22-A114F exceeds 1000 V
 - ♦ MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- CMOS low power consumption
- Input/output tolerant up to 3.6 V
- Dynamic Controlled Output (DCO) circuit dynamically changes output impedance, resulting in noise reduction without speed degradation
- Low inductance multiple V_{CC} and GND pins to minimize noise and ground bounce
- Supports Live Insertion

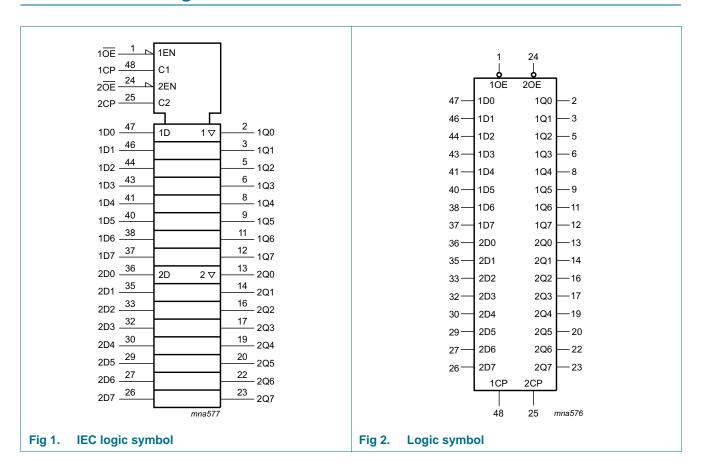


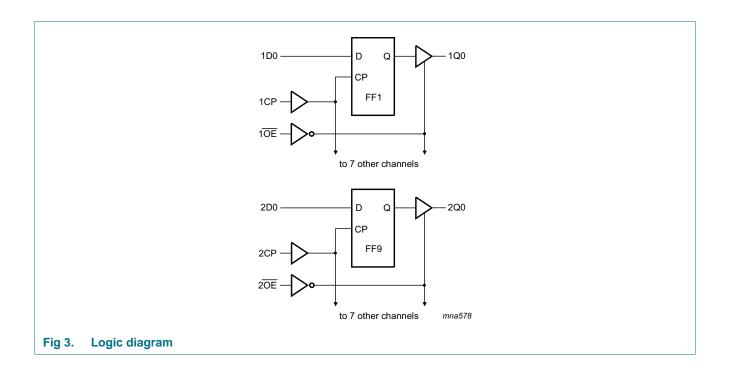
3. Ordering information

Table 1. Ordering information

Type number	Package					
	Temperature range	Name	Description	Version		
74AVC16374DGG-Q100	−40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1		

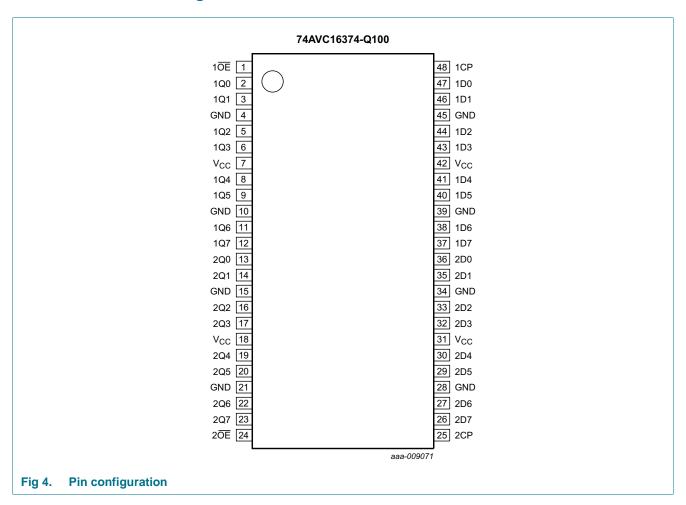
4. Functional diagram





5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1 OE	1	output enable input (active LOW)
1Q0 to 1Q7	2, 3, 5, 6, 8, 9, 11, 12	3-state flip-flop outputs
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
2Q0 to 2Q7	13, 14, 16, 17, 19, 20, 22, 23	3-state flip-flop outputs
2 OE	24	output enable input (active LOW)
2CP	25	clock input
2D0 to 2D7	36, 35, 33, 32, 30, 29, 27, 26	data input/output
1D0 to 1D7	47, 46, 44, 43, 41, 40, 38, 37	data input/output
1CP	48	clock input

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6. Functional description

Table 3. Function table[1]

Operating modes	Inputs			Internal flip-flops	Outputs
	nOE	nCp	nDn		nQn
Load and read register	L	1	I	L	L
	L	1	h	Н	Н
Load register and disable outputs	Н	1	I	L	Z
	Н	1	h	Н	Z

[1] H = HIGH voltage level

 $h = HIGH \ voltage \ level \ one \ set-up \ time \ prior \ to \ the \ LOW-to-HIGH \ CP \ transition$

L = LOW voltage level

I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition

Z = high-impedance OFF-state

↑ = LOW-to-HIGH CP transition

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+4.6	V
I _{IK}	input clamping current	V _I < 0 V		-	-50	mA
VI	input voltage		[1]	-0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V		-50	-	mA
Vo	output voltage	output HIGH or LOW	[1]	-0.5	V _{CC} + 0.5	V
		output 3-state	[1]	-0.5	+4.6	V
Io	output current	$V_O = 0 \text{ V to } V_{CC}$		-	±50	mA
I _{CC}	supply current			-	+100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	[2]	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^[2] Above 60 $^{\circ}\text{C},$ the value of P $_{tot}$ derates linearly with 5.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage	according to JEDEC Low Voltage Standards	1.4	-	1.6	V
			1.65	-	1.95	V
			2.3	-	2.7	V
			3.0	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
VI	input voltage		0	-	3.6	V
Vo	output voltage	output HIGH or LOW	0	-	V_{CC}	V
		output 3-state	0	-	3.6	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
Δt/ΔV	input transition rise and fall	V _{CC} = 1.4 V to 1.6 V	0	-	40	ns/V
	rate	V _{CC} = 1.65 V to 2.3 V	0	-	30	ns/V
		V _{CC} = 2.3 V to 3.0 V	0	-	20	ns/V
		V _{CC} = 3.0 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T _{amb} = -4	40 °C to +85 °C					
V_{IH}	HIGH-level input voltage	V _{CC} = 1.2 V	V _{CC}	-	-	V
		V _{CC} = 1.4 V to 1.6 V	$0.65 \times V_{CC}$	0.9	-	V
		V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	0.9	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	1.2	-	V
		V _{CC} = 3.0 V to 3.6 V	2.0	1.5	-	V
V_{IL}	LOW-level input voltage	V _{CC} = 1.2 V	-	-	GND	V
		V _{CC} = 1.4 V to 1.6 V	-	0.9	$0.35 \times V_{CC}$	V
		V _{CC} = 1.65 V to 1.95 V	-	0.9	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	1.2	0.7	V
		V _{CC} = 3.0 V to 3.6 V	-	1.5	0.8	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH}$ or V_{IL}				
		$I_{O} = -100 \mu A$; $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.20	V _{CC}	-	V
		$I_{O} = -3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	V _{CC} - 0.35	V _{CC} - 0.23	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	V _{CC} - 0.45	V _{CC} - 0.25	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	V _{CC} - 0.55	V _{CC} - 0.38	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	V _{CC} - 0.70	V _{CC} - 0.48	-	V

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 100 \ \mu A; \ V_{CC} = 1.65 \ V \ to \ 3.6 \ V$	-	GND	0.20	V
		$I_O = 3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	0.10	0.35	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.10	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.26	0.55	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.36	0.70	V
l _l	input leakage current	per pin; $V_I = V_{CC}$ or GND; $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	0.1	2.5	μА
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 3.6 \text{ V}$; $V_{CC} = 0.0 \text{ V}$	-	±0.1	±10	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND				
		V _{CC} = 1.4 V to 2.7 V	-	0.1	5	μΑ
		V _{CC} = 3.0 V to 3.6 V	-	0.1	10	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A				
		V _{CC} = 1.4 V to 2.7 V	-	0.1	20	μΑ
		V _{CC} = 3.0 V to 3.6 V	-	0.2	40	μΑ
Cı	input capacitance		-	5	-	pF

^[1] All typical values are measured at T_{amb} = 25 °C.

9.1 Graphs

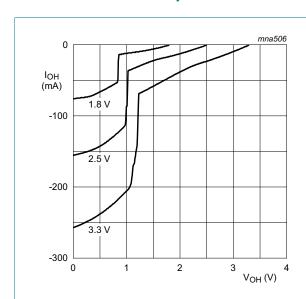


Fig 5. Output voltage as a function of the HIGH-level output current.

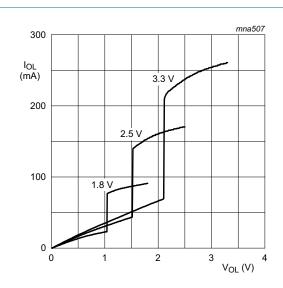


Fig 6. Output voltage as a function of the LOW-level output current.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). $t_r = t_f \le 2$ ns. For test circuit, see <u>Figure 10</u>.

Symbol	Parameter	Conditions	-40 °C to +85 °C			Unit
			Min	Typ[2]	Max	
pd	propagation delay	nCP to nQn; see Figure 7				
		V _{CC} = 1.2 V	-	3.1	-	ns
		V _{CC} = 1.4 V to 1.6 V	1.2	2.4	8.4	ns
		V _{CC} = 1.65 V to 1.95 V	1.0	2.0	6.7	ns
		V _{CC} = 2.3 V to 2.7 V	8.0	1.5	4.1	ns
		V _{CC} = 3.0 V to 3.6 V	0.7	1.3	3.3	ns
- en	enable time	nOE to nQn, nBn; see Figure 8				
		V _{CC} = 1.2 V	-	5.4	-	ns
		V _{CC} = 1.4 V to 1.6 V	1.6	3.9	8.5	ns
		V _{CC} = 1.65 V to 1.95 V	2.3	3.3	6.7	ns
		V _{CC} = 2.3 V to 2.7 V	0.9	2.3	4.3	ns
		V _{CC} = 3.0 V to 3.6 V	0.7	2.0	3.4	ns
dis	disable time	nOE to nQn; see Figure 8				
		V _{CC} = 1.2 V	-	5.6	-	ns
		V _{CC} = 1.4 V to 1.6 V	2.5	4.5	9.4	ns
		V _{CC} = 1.65 V to 1.95 V	1.8	3.3	7.8	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	1.8	4.2	ns
		V _{CC} = 3.0 V to 3.6 V	1.2	2.0	3.9	ns
w	pulse width	HIGH; nCP; see Figure 7				
		V _{CC} = 1.2 V	-	0.8	-	ns
		V _{CC} = 1.4 V to 1.6 V	-	0.5	-	ns
		V _{CC} = 1.65 V to 1.95 V	3.1	0.3	-	ns
		V _{CC} = 2.3 V to 2.7 V	2.5	0.2	-	ns
		V _{CC} = 3.0 V to 3.6 V	2.5	0.2	-	ns
su	set-up time	nDn to nCP; see Figure 8				
		V _{CC} = 1.2 V	-	-0.6	-	ns
		V _{CC} = 1.4 V to 1.6 V	2.7	-0.3	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.9	-0.3	-	ns
		V _{CC} = 2.3 V to 2.7 V	1.4	-0.2	-	ns
		V _{CC} = 3.0 V to 3.6 V	1.4	-0.1	-	ns
h	hold time	nDn to nCP; see Figure 8				
		V _{CC} = 1.2 V	-	0.8	-	ns
		V _{CC} = 1.4 V to 1.6 V	1.3	0.7	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.2	0.6	-	ns
		V _{CC} = 2.3 V to 2.7 V	1.1	0.5	-	ns
		V _{CC} = 3.0 V to 3.6 V	1.1	0.4	-	ns

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). $t_r = t_f \le 2$ ns. For test circuit, see <u>Figure 10</u>.

Symbol Parameter		Conditions	-40	°C to +85	s °C	Unit
			Min	Typ[2]	Max	
f _{max}	maximum frequency	see Figure 8				
		V _{CC} = 1.2 V	-	250	-	MHz
		V _{CC} = 1.4 V to 1.6 V	-	300	-	MHz
		V _{CC} = 1.65 V to 1.95 V	160	320	-	MHz
		V _{CC} = 2.3 V to 2.7 V	200	350	-	MHz
		V _{CC} = 3.0 V to 3.6 V	200	350	-	MHz
C _{PD}	power dissipation	per input; V _I = GND to V _{CC}				
	capacitance	outputs enabled	-	66	-	pF
		outputs disabled	-	1	-	pF

- [1] t_{pd} is the same as t_{PLH} and t_{PHL} . t_{en} is the same as t_{PZL} and t_{PZH} . t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [2] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V respectively.
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

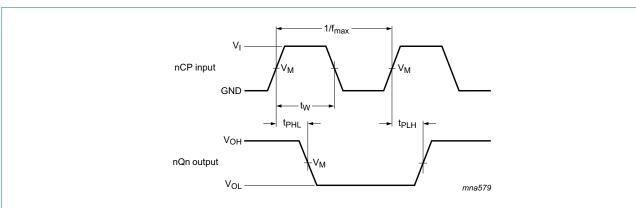
C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

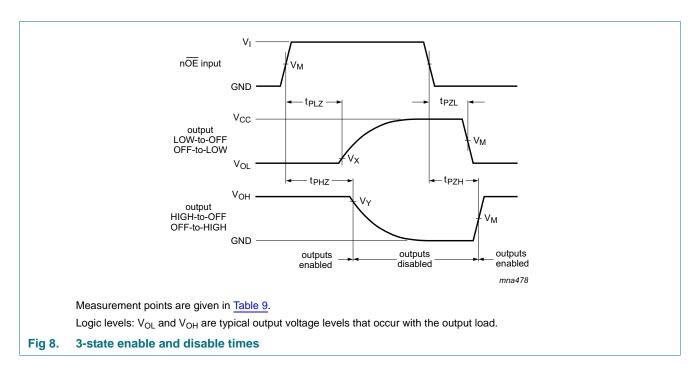
11. Waveforms



Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 7. Clock input (nCP) to output (nQn) propagation delays



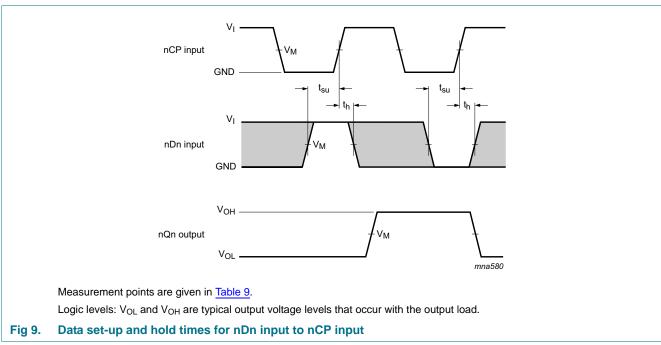
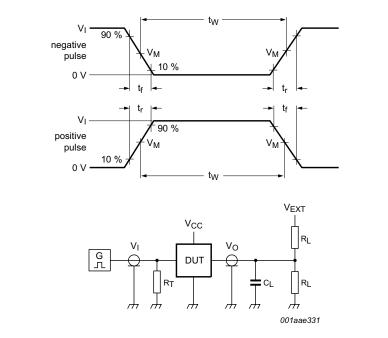


Table 8. Measurement points

Supply voltage	V _M	Input	Input				
V _{CC}		VI	$t_r = t_f$	V _X	V _Y		
1.2 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
1.4 V to 1.6 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
1.65 V to 1.95 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
3.0 V to 3.6 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	V _{OL} + 0.3 V	V _{OH} – 0.3 V		



Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	≤ 2 ns	15 pF	2 kΩ	open	2 × V _{CC}	GND	
1.4 V to 1.6 V	V _{CC}	≤ 2 ns	15 pF	2 kΩ	open	2 × V _{CC}	GND	
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	open	2 × V _{CC}	GND	
2.3 V to 2.7 V	V _{CC}	≤ 2 ns	30 pF	500 Ω	open	2 × V _{CC}	GND	
3.0 V to 3.6 V	V _{CC}	≤ 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	

12. Package outline

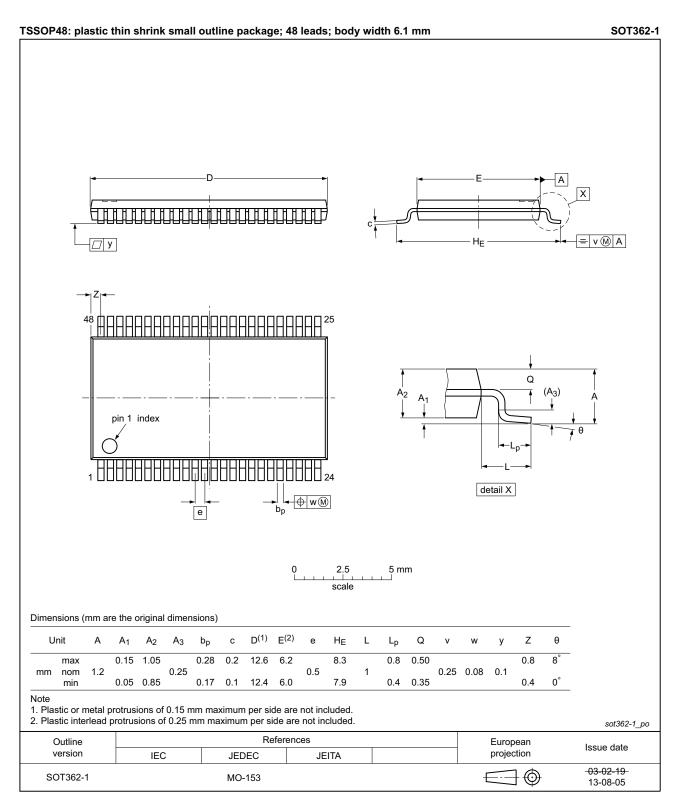


Fig 11. Package outline SOT362-1 (TSSOP48)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description			
CMOS	mplementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
MIL	Military			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AVC16374_Q100 v.2	20150316	Product data sheet	-	74AVC16374_Q100 v.1
Modifications:	 Section 2: ESD protection; for MIL-STD-883 (method 3015) and HBM JESD22-A114F the value is changed from 2000 V to 1000 V. 			
74AVC16374_Q100 v.1	20130916	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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17. Contents

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